

## SLIM SERIES 50 - 250 WATT

### FEATURES

- Fully qualified to Class H or K
- Radiation hardened
- -55°C to +125°C operating temp
- 40 to 80 VDC input
- Fixed frequency, 550 kHz typical
- Topology – Non-isolated buck
- 35 VDC input with lowered efficiency
- Up to 90 V for up to 120 ms transient protection
- 35 VDC output
- Inhibit function
- Power readiness function
- Load fault/short circuit protection
- Up to 94% efficiency, 90 W/in<sup>3</sup>

## LINE INTERFACE MODULE 40 TO 80 VDC INPUT 50 OR 250 WATT OUTPUT



SLIM5050

Size (max.): Non flanged

1.460 x 1.130 x 0.330 (37.08 x 28.70 x 8.38 mm)

Flanged

2.005 x 1.130 x 0.330 (50.93 x 28.70 x 8.38 mm)

See Section B8, cases E1 and G1, for dimensions.

Weight: 30 grams typical

Screening: Standard, Class H, or Class K (MIL-PRF-38534)

Radiation hardness levels O, L, and R

Section C2 for screening and radiation hardness

options, see Section A5 for ordering information.

### MODEL THROUGHPUT POWER

MODEL	WATTS
SLIM5050™	50
SLIM50250™	250

### DESCRIPTION

The SLIM50™ Series of line interface modules for space provide a nominal output voltage of 35 VDC from input voltages of 45 to 75 VDC with efficiencies of 94% or higher. Sustained operation at voltages as high as 80 or as low as 35 are possible with reduced efficiency. The SLIM5050 module delivers 50 watts of output power over the full military temperature range of -55°C to +125°C and fits in a package of 1.460 x 1.130 x 0.330 inches (37.08 x 28.70 x 8.38 mm) maximum, resulting in a power density of over 91 watts/in<sup>3</sup>.

### SCREENING AND REPORTS

The SLIM5050 module offers three screening options – Standard, Class H, or Class K – and three levels of radiation hardness. See Section C2, Quality Assurance, pages C2-7 through C2-9, for descriptions. Detailed reports on product performance are also available and are listed on page C2-9.

### CONVERTER DESIGN

The SLIM5050 modules are non-isolated converters operating at a frequency between 500 kHz and 600 kHz. The control circuitry uses average current mode control to achieve a wide bandwidth with little or no overshoot over a wide range of loads. These converters are specifically designed to accommodate loads with a negative impedance such as those presented by Interpoint DC/DC converters with a constant power consumption.

### PARALLEL OPERATION: UP TO 10 MODULES

Up to 10 SLIM Series™ modules can be paralleled for increased power. Current sharing is typically within 2%.

### OVERLOAD AND CURRENT LIMIT

Current overload protection is accomplished by monitoring the output current resulting in a constant current mode when the load

exceeds approximately 125% of rated load at full output voltage. When the overload condition forces the output voltage to drop the maximum current delivered falls from approximately 1.9 amps to less than 1.5 amps. This feature keeps the short circuit dissipation low and forces the output voltage to collapse rapidly thereby preventing operation in an abnormal condition. Combined with the "Power Ready" signal (see below), this foldback of the output current prevents power cycling of the downstream converters.

### POWER READY SIGNAL

To avoid high current surges during power up, the interface module has a signal intended to connect to the inhibit lines of Interpoint converters to keep these converters turned off until the interface module's output exceeds approximately 13 volts thereby assuring that, in an overload condition, the converters powered by the interface module will shut off before the power ready signal turns them off. This feature prevents repeated limit cycling in an overload condition.

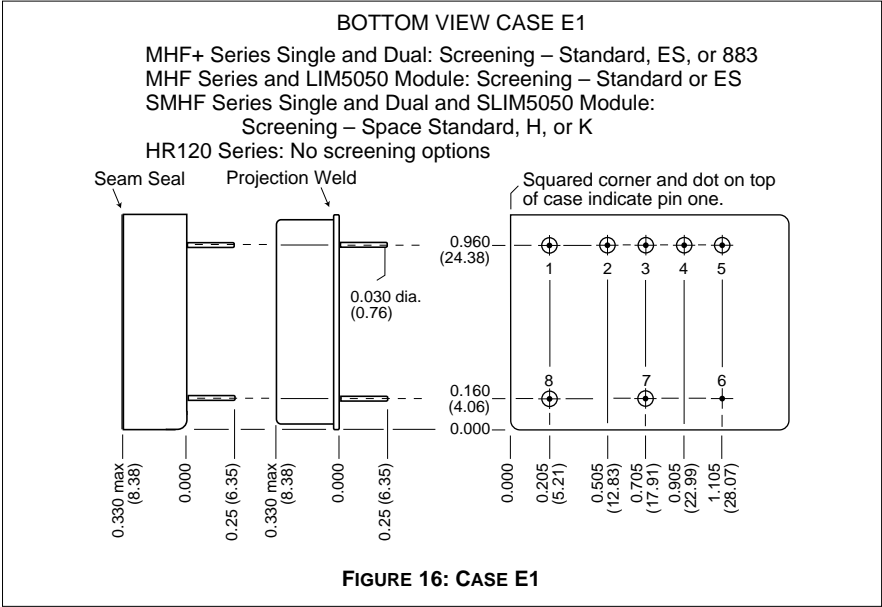
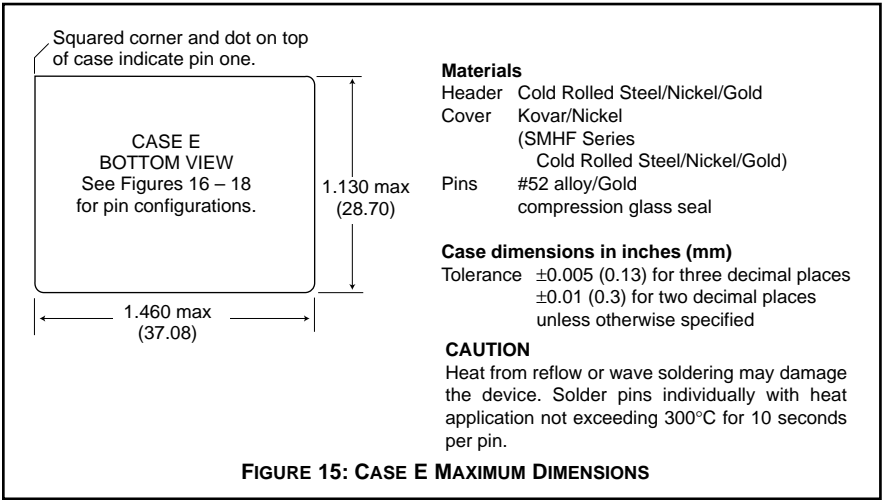
### INHIBIT

The SLIM Series modules have an open collector TTL compatible inhibit terminal that can be used to disable power conversion, resulting in a very low quiescent input current and no generation of switching noise.

**Future offerings are planned for the SLIM Series of modules. Please contact your Interpoint representative listed in Section A5, for more details.**

CASE E

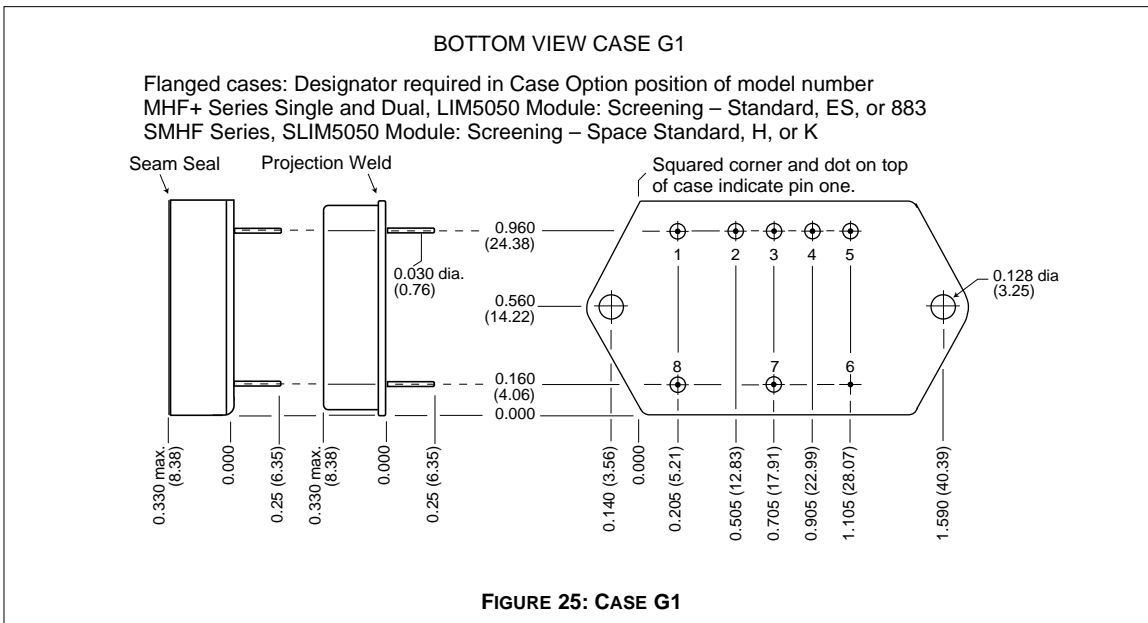
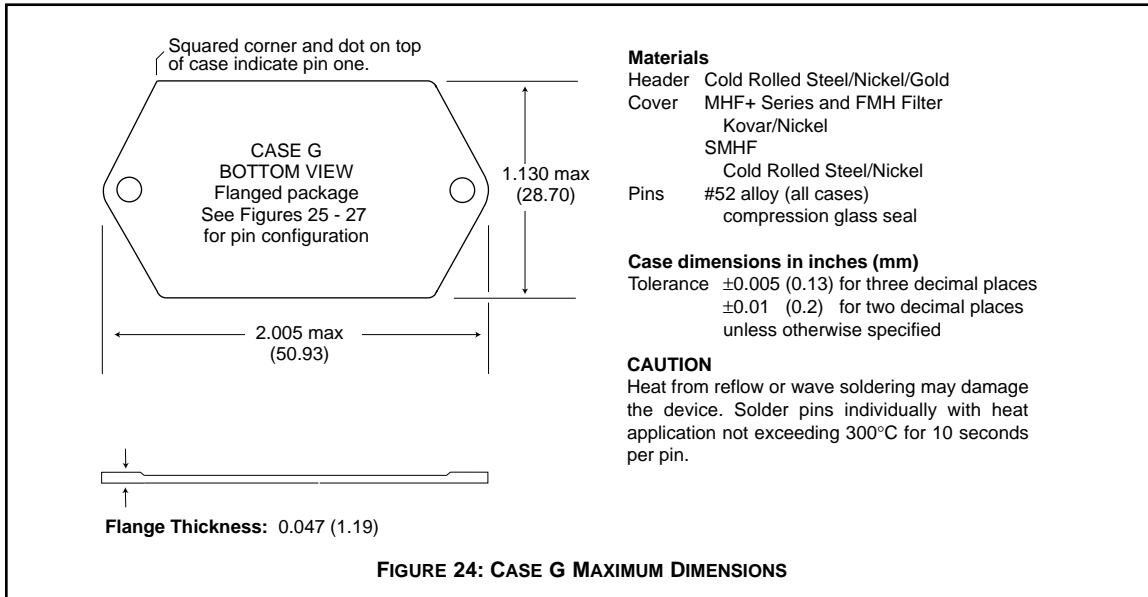
CASES



Note: Although every effort has been made to render the case drawings at actual size, variations in the printing process may cause some distortion. Please refer to the numerical dimensions for accuracy.

# CASES

## CASE G



Note: Although every effort has been made to render the case drawings at actual size, variations in the printing process may cause some distortion. Please refer to the numerical dimensions for accuracy.

## QA SCREENING SPACE PRODUCTS

### SPACE PRODUCTS

ELEMENT EVALUATION TEST PERFORMED (COMPONENT LEVEL)	STANDARD (O)		CLASS H		CLASS K	
	M/S	P	M/S	P	M/S	P
Element Electrical	yes	no	yes	yes	yes	yes
Element Visual	no	no	yes	yes	yes	yes
Internal Visual	no	no	yes	no	yes	no
Temperature Cycling	no	no	no	no	yes	yes
Constant Acceleration	no	no	no	no	yes	yes
Interim Electrical	no	no	no	no	yes	no
Burn-in	no	no	no	no	yes	no
Post Burn-in Electrical	no	no	no	no	yes	no
Steady State Life	no	no	no	no	yes	no
Voltage Conditioning /Aging	no	no	no	no	no	yes
Visual Inspection	no	no	no	no	no	yes
Final Electrical	no	no	yes	yes	yes	yes
Wire Bond Evaluation*	no	no	yes	yes	yes	yes
SEM	no	no	no	no	yes	no
SLAM™/C-SAM: Input capacitors only (Add'l test, not req. by H or K)	no	no	no	yes	no	yes

#### Notes

- M/S Active components (Microcircuit and Semiconductor Die)
- P Passive components
- \* Not applicable to EMI filters that have no wirebonds

#### Definitions

Element Evaluation: Component testing/screening per MIL-STD-883 as determined by MIL-PRF-38534

SEM: Scanning Electron Microscopy

SLAM™: Scanning Laser Acoustic Microscopy

C-SAM: C - Mode Scanning Acoustic Microscopy

Applies to the following products:

SMFLHP Series

SMFL Series

SMHP Series (O&H only)

SMTR Series

SSP Series

SMHF Series

SMSA Series

SLH Series

SLIM Module

SFME120 EMI Filter

SFME28 EMI Filter

SFCS EMI Filter

SFMC EMI Filter

STF EMI Filter

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## QA SCREENING SPACE PRODUCTS

ENVIRONMENTAL SCREENING TEST PERFORMED (END ITEM LEVEL)	STANDARD (O)	CLASS H	CLASS K
Non-destruct bond pull* Method 2023	no	no	yes
Pre-cap inspection Method 2017, 2032	yes	yes	yes
Temperature cycle Method 1010, Cond. C	yes	yes	yes
Constant acceleration Method 2001, 3000 g	yes	yes	yes
PIND Test Method 2020, Cond. B	no	no	yes
Radiography Method 2012	no	no	yes
Pre burn-in test	yes	yes	yes
Burn-in, Method 1015, 125°C			
96 hours	yes	no	no
160 hours	no	yes	no
2 x 160 hour (includes mid BI test)	no	no	yes
Final electrical test MIL-PRF-38534, Group A	yes	yes	yes
Hermeticity test			
Fine Leak, Method 1014, Cond. A	yes	yes	yes
Gross Leak, Method 1014, Cond. C	yes	yes	yes
Final visual inspection Method 2009	yes	yes	yes

Test methods are referenced to MIL-STD-883 as determined by MIL-PRF-38534.

### Note

\* Not applicable to EMI filters that have no wirebonds.

Applies to the following products:

SMFLHP Series	SMHF Series
SMFL Series	SMSA Series
SMHP Series (O&H only)	SLH Series
SMTR Series	SLIM Module
SSP Series	SFME120 EMI Filter

SFME28 EMI Filter  
SFCS EMI Filter  
SFMC EMI Filter  
STF EMI Filter

## QA SCREENING SPACE PRODUCTS

### RADIATION HARDNESS LEVELS FOR DC/DC CONVERTERS AND LINE INPUT MODULES<sup>1</sup>

PRODUCT LEVEL AVAILABILITY  RADIATION HARDNESS LEVELS	ENVIRONMENTAL SCREENING LEVELS		
	STANDARD (O)	CLASS H	CLASS K
<b>O:</b> Standard, no radiation guarantee For system evaluation, electrically and mechanically comparable to H and K level.	OO	HO	Not available
<b>L:</b> Radiation hardened – Tested lots Up to 50 k Rads (Si) total dose No SEU guarantee	Not available	HL	KL
<b>R:</b> Radiation hardened – Tested lots Up to 100 k Rads (Si) total dose SEU guarantee up to 40 MeV	Not available	HR	KR

L and R are referenced to MIL-PRF-38534, appendix G, Radiation Hardness Assurance (RHA) levels.

#### Note

1. Interpoint's **EMI filters** are designed exclusively with passive components providing maximum tolerance for space environment requirements.

Applies to the following products:

SMFLHP Series (levels O and L only)	SMHF Series
SMFL Series (levels O and L only)	SMSA Series
SMTR Series	SLH Series
SSP Series	SLIM Series Modules

#### REPORTS: INCLUDED WITH PURCHASE OF PRODUCT HL, KL, HR, or KR

1. Radiation Susceptibility Analysis
2. Electrical/Thermal Stress Analysis and Derating Report
3. MTBF Report
4. FMEA Report

**OO** option: Select reports available as separate purchases.

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